

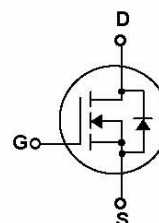
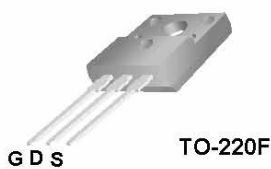
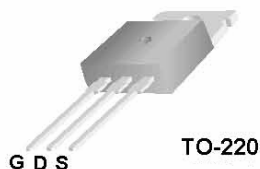
1 Description

These N-Channel enhancement mode power field effect transistors are produced using planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.

2 Features

- 800V / 7A
- $R_{DS(on)} = 1.3\Omega(\text{typ}) \cdot V_{GS} = 10V, I_D = 3.5A$
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability..



3 Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	APQ07SN80BH-XXM0	APQ07SN80BF-XXM0	Units
		APQ07SN80BH-XXJ0	APQ07SN80BF-XXJ0	
		TO-220	TO-220F	
V_{DSS}	Drain-Source Voltage	800		V
I_D	Drain Current - Continuous ($T_C = 25^\circ\text{C}$) - Continuous ($T_C = 100^\circ\text{C}$)	7		A
		4.4		
I_{DM}	Drain Current – Pulsed ①	28		A
V_{GS}	Gate-Source Voltage	± 30		V
E_{AS}	Single Pulsed Avalanche Energy ②	534		mJ
I_{AR}	Avalanche Current	7		A
P_D	Power Dissipation ($T_C = 25^\circ\text{C}$) - De-rate above 25°C	154	50	W
		1.23	0.4	
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +150		$^\circ\text{C}$
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300		$^\circ\text{C}$

* note :

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② $V_{DD} = 135V$, starting $T_J = 25^\circ\text{C}$, $L = \text{TBD}$, $R_G = 20\Omega$, $I_{AS} = 5.50A$
- ③ $ISD \leq 3A$, $di/dt \leq 200A/\mu\text{s}$, $V_{DD} \leq V_{(BR)DSS}$, $T_J \leq 150^\circ\text{C}$.



4 Thermal Characteristics

Symbol	Parameter	APQ07SN80BH-XXM0	APQ07SN80BF-XXM0	Units
		APQ07SN80BH-XXJ0	APQ07SN80BF-XXJ0	
		TO-220	TO-220F	
R _{θJC}	Thermal Resistance, Junction-to-Case	0.81	2.5	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient	62.5	120	°C/W

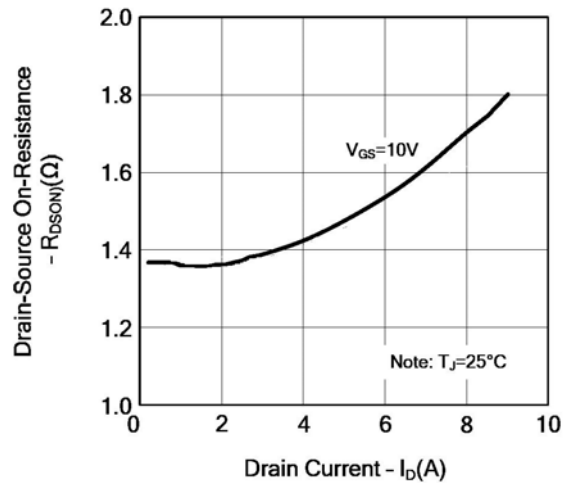
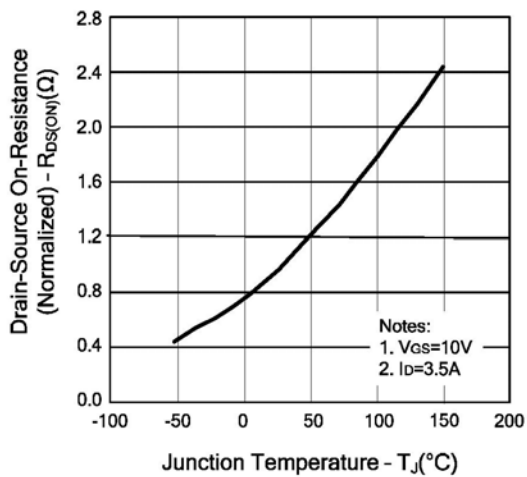
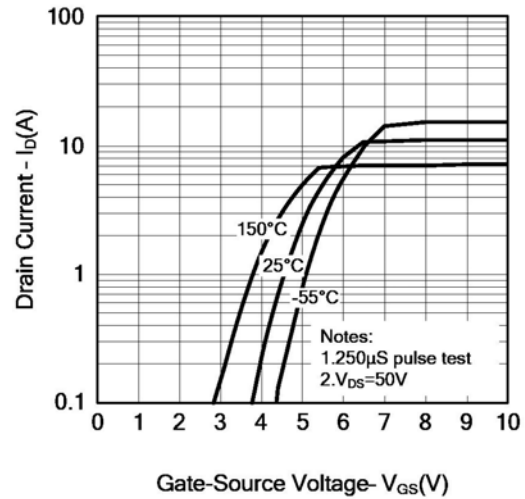
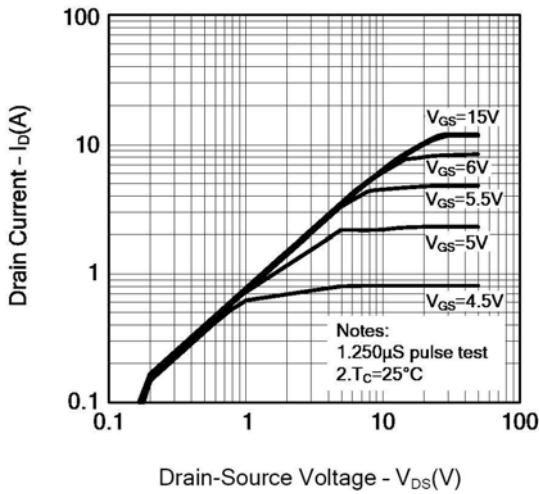
5 Electrical Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	800	--	--	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C	--	1	--	V/°C
I _{DSS}	Gate to Source leakage current	V _{DS} = 800 V, V _{GS} = 0 V	--	--	1	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V	--	--	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V	--	--	-100	nA
On Characteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	2.0	--	4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 3.5 A ④	--	1.39	1.55	Ω
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz	--	1087	--	pF
C _{oss}	Output Capacitance		--	104	--	pF
C _{rss}	Reverse Transfer Capacitance		--	5.65	--	pF
Switching Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{DD} = 400 V, I _D = 7A, R _G = 25 Ω ④	--	33.6	--	ns
t _r	Turn-On Rise Time		--	72	--	ns
t _{d(off)}	Turn-Off Delay Time		--	63.3	--	ns
t _f	Turn-Off Fall Time		--	35.3	--	ns
Q _g	Total Gate Charge	V _{DS} = 640 V, I _D = 7A, V _{GS} = 10 V ④	--	23.2	--	nC
Q _{gs}	Gate-Source Charge		--	6.98	--	nC
Q _{gd}	Gate-Drain Charge		--	8.97	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I _S	Maximum Continuous Drain-Source Diode Forward Current		--	--	7	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	28	A
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 7 A	--	--	1.4	V

t_{rr}	Reverse Recovery Time	$V_{GS} = 0\text{ V}, I_S = 7\text{ A},$ $di_F/dt = 100\text{ A}/\mu\text{s}$ ④	--	190	--	ns
Q_{rr}	Reverse Recovery Charge		--	0.53	--	μC

Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② $V_{DD}=135\text{V}$, starting $T_J=25^\circ\text{C}$, $L=TBD$, $R_G=20\Omega$, $I_{AS}=5.5\text{A}$
- ③ $I_{SD} \leq 3\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq V(BR)DSS$, $T_J \leq 150^\circ\text{C}$
- ④ Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$. Depend on FT Test.
- ⑤ CP Test

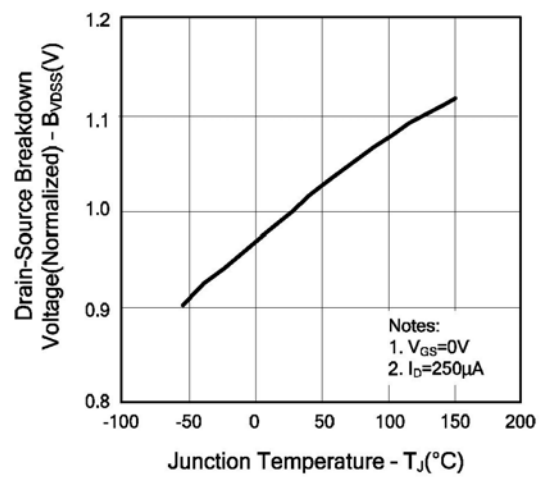
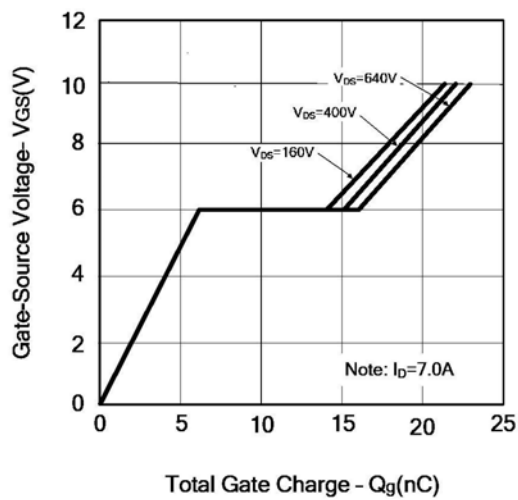
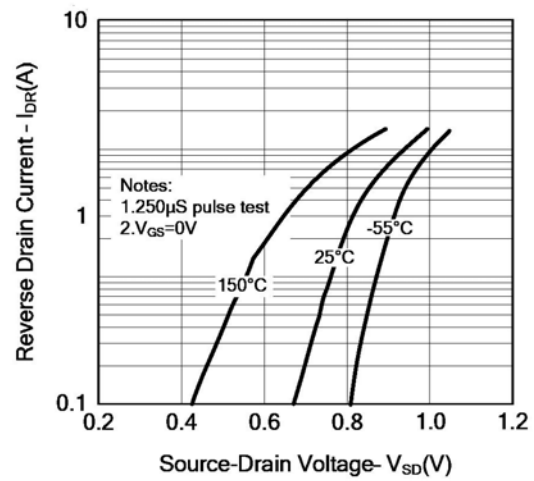
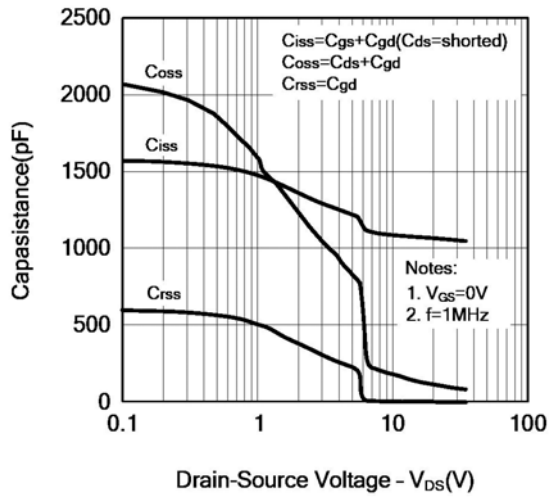


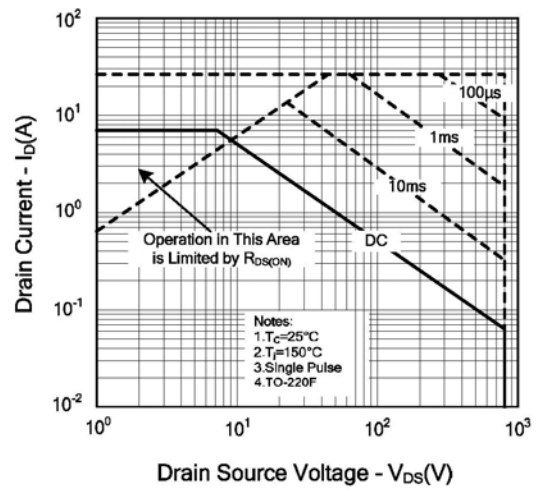
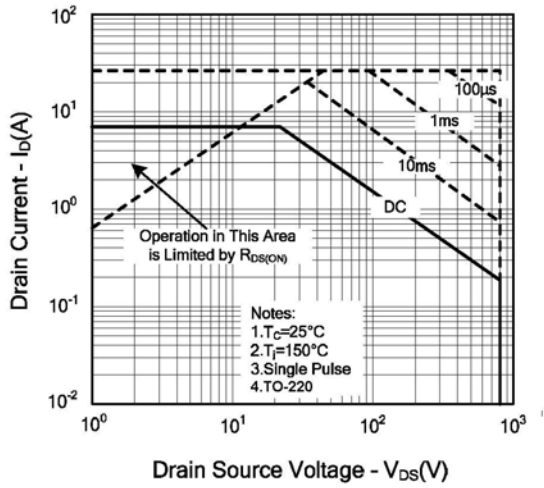
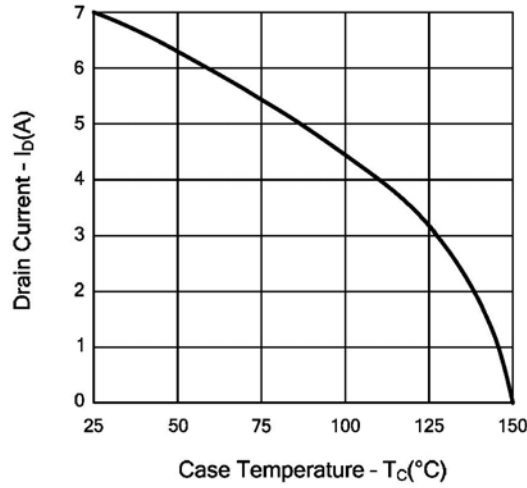


DEVICE SPECIFICATION

APQ07SN80BH
APQ07SN80BF

800V/7A N-Channel MOSFET

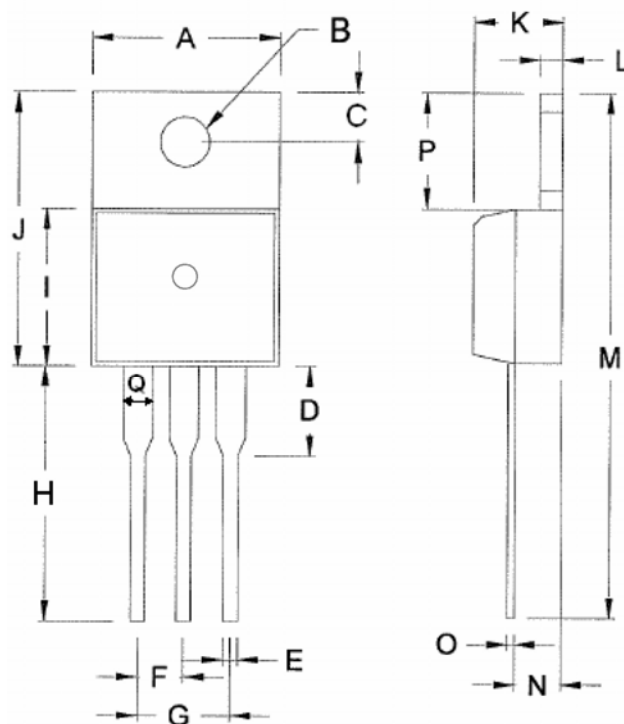




6 Package Dimensions

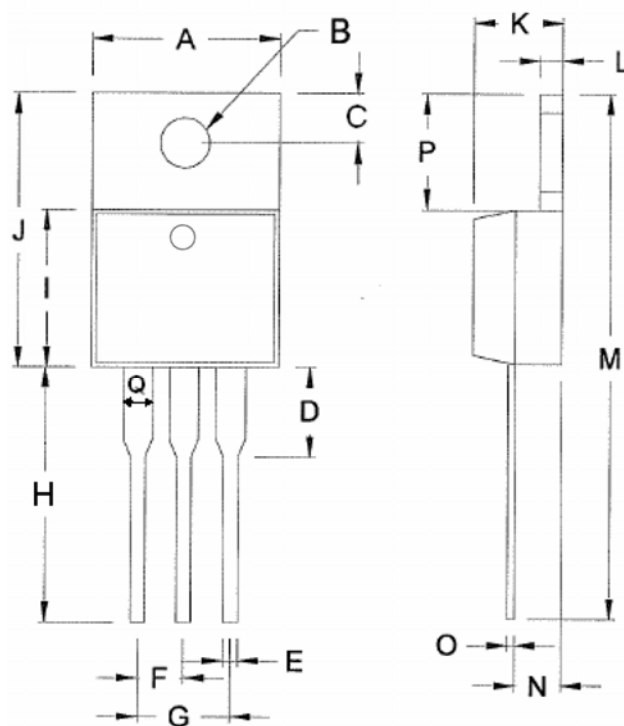
APQ07SN80BH-XXM0
TO-220

TO-220 DIMENSION			
DIM	MILLIMETERS		
	MIN	MAX	TYP.
A	10.04	10.41	10.23
B	3.66	3.88	3.77
C	2.50	2.84	2.67
D	3.31	4.50	3.91
E	0.70	0.91	0.81
F	2.54(typ.)		2.54
G	5.08(typ.)		5.08
H	13.47	14.20	13.84
I	8.50	9.00	8.80
J	14.80	15.49	15.15
K	4.32	4.57	4.45
L	1.22	1.42	1.30
M	28.27	29.69	28.98
N	2.40	2.90	2.65
O	0.36	0.53	0.45
P	5.97	6.47	6.22
Q	1.15	1.45	1.30



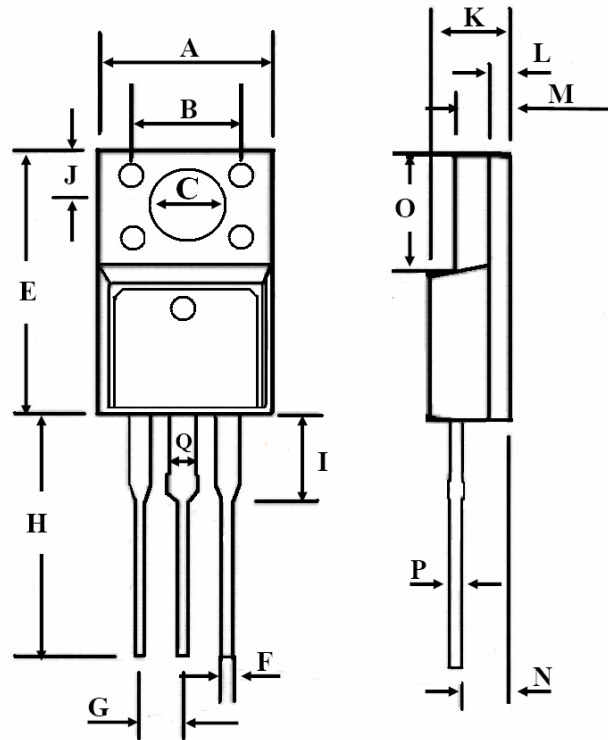
APQ07SN80BH-XXJ0
TO-220

TO-220 DIMENSION			
DIM	MILLIMETERS		
	MIN	MAX	TYP.
A	10.01	10.31	10.16
B	3.66	3.94	3.80
C	2.59	2.89	2.74
D	3.5	3.96	3.73
E	0.70	0.90	0.80
F	2.54 TYP.		
G	4.98	5.18	5.08
H	13.4	13.8	13.6
I	8.5	8.9	8.70
J	14.65	15.35	15.05
K	4.47	4.67	4.57
L	1.22	1.42	1.32
M	28.05	29.15	28.60
N	2.52	2.82	2.67
O	0.31	0.53	0.42
P	6.10	6.50	6.30
Q	1.17	1.37	1.27



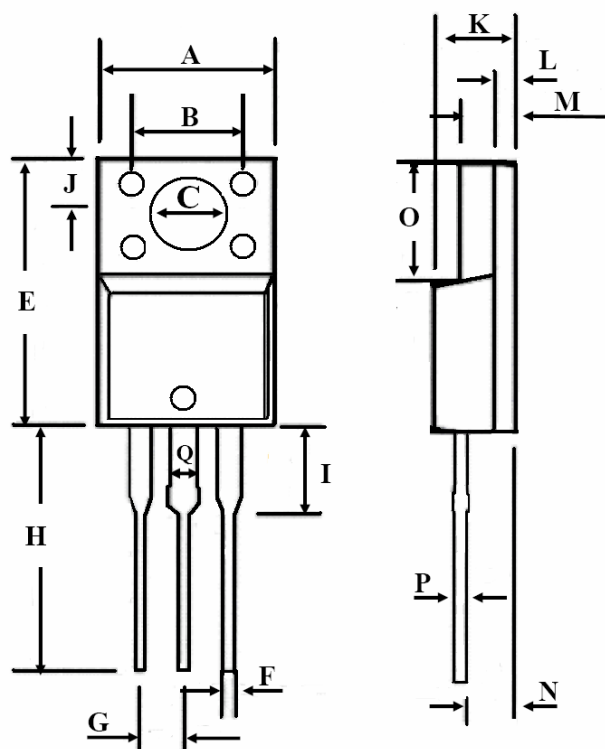
APQ07SN80BF—XXM0
TO-220F

TO-220F DIMENSION			
DIM	MILLIMETERS		
	MIN	MAX	TYP.
A	9.96	10.36	10.16
B	6.50 TYP.		6.50
C	3.00	3.20	3.10
E	15.10	16.07	15.59
F	0.55	1.39	0.97
G	2.54 TYP.		
H	12.37	13.5	12.94
I	2.23	3.90	3.07
J	2.90	3.50	3.2
K	4.45	4.93	4.69
L	1.15 TYP.		
M	2.34	2.74	2.54
N	2.56	2.96	2.76
O	6.50	7.10	6.8
P	0.36	0.68	0.52
Q	1.15	1.66	1.41



APQ07SN80BF-XXJ0
TO-220F

TO-220F DIMENSION			
DIM	MILLIMETERS		
	MIN	MAX	TYP.
A	9.96	10.36	10.16
B	6.50 TYP.		
C	3.5 REF.		
E	14.8	15.2	15.0
F	0.45	0.75	0.55
G	2.54 TYP.		
H	13.23	14.33	13.78
I	3.60	4.00	3.80
J	2.70 TYP.		
K	4.30	4.70	4.50
L	1.30 TYP.		
M	2.80	3.20	3.00
N	2.50	2.90	2.70
O	6.50	7.10	6.8
P	0.45	0.75	0.55
Q	1.05	1.75	1.40





DEVICE SPECIFICATION

APQ07SN80BH
APQ07SN80BF

800V/7A N-Channel MOSFET

Note

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